JUL 2 6 2007

AMENDMENT TRANSMITTAL LETTER						Docket No. ISH-0234	
Application No. 10/543,166-Conf. #7946		Filing Date July 22, 2005		Examiner A. Aboulfaida		Art Unit 2812	
oplicant(s): Hide							
vention: SILICO	N SEMICOND	UCTOR SUBS	STRATE AND	METHOD FOR M	ANUFACT	URING THE	
TO THE COMMISSIONER FOR PATENTS							
Fransmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.							
CLAIMS AS AMENDED							
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate			
Total Claims	10	- 20 =	0	x 50.00		0.00	
Independent Claims	2	- 3 =	0	x 200.00		0.00	
Multiple Dependent Claims (check if applicable)							
Other fee (please specify):							
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:						0.00	
x Large Entity				Small Entity	/		
No additional fee is required for this amendment.							
Please charge Deposit Account No in the amount of \$ A duplicate copy of this sheet is enclosed.							
A check in the amount of \$ to cover the filing fee is enclosed.							
Payment by credit card. Form PTO-2038 is attached.							
	is hereby auth below. A dup			Deposit Account Nenclosed.	No. <u>18-</u>	0013	
x Credit a	ny overpaymer	nt.					
X Charge a	any additional fil	ing or application	n processing	fees required under	37 CFR 1.1	6 and 1.17.	
77				Dated:	July 26,	2007	
Lée Cheng/Bria Attorney/Agent		949/47,255					
RADER, FISHM 1233 20th Stree Suite 501 Washington, D0 (202) 955-3750	et, N.W. C 20036	R PLLC					



Docket No.: ISH-0234

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Hideki Yamanaka et al.

Application No.: 10/543,166

Filed: July 22, 2005

For: SILICON SEMICONDUCTOR SUBSTRATE

AND METHOD FOR MANUFACTURING

THE SAME

Art Unit: 2809

Examiner: A. Aboulfaida

Confirmation No.: 7946

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated May 9, 2007, please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.